



MATERIAL : A1050 OR A6061
 WEIGHT : ABOUT 3.5 [kg]
 RECOMMENDED FLOW RATE : 6~10 [L/min]
 (LIQUID: PURIFIED WATER OR ANTICORROSIVE COOLANT FOR AUTOMOBILE)
 THERMAL RESISTANCE : BELOW 0.0015 [°C/W]
 (AT RECOMMENDED FLOW RATE)
 SCALE : NOT TO SCALE (NTS)
 UNIT : mm
 PROJECTION : THIRD ANGLE PROJECTION METHOD
 DIMENSIONAL TOLERANCE : ±0.5

1. Performance data on drawings, catalogs, handling manuals, and our documentation is reference only, and is not guaranteed.
2. This product is designed by us. Production and copy of this product without our permission is not permitted.

TITLE	COLD PLATE
USE FOR	300 [mm] SILICON WAFER, OTHERS
ITEM NUMBER	R-800AL